UNITED STATES SECURITIES AND EXCHANGE COMMISSION

WASHINGTON, DC 20549

FORM 8-K

CURRENT REPORT
Pursuant to Section 13 or 15(d)
of the Securities Exchange Act of 1934

Date of report (Date of earliest event reported) August 14, 2013

TTM TECHNOLOGIES, INC.

(Exact Name of Registrant as Specified in Charter)

DELAWARE (State or other jurisdiction of incorporation) 0-31285 (Commission File Number) 91-1033443 (IRS Employer Identification Number)

1665 SCENIC AVENUE, SUITE 250 COSTA MESA, CALIFORNIA 92626 (Address of Principal Executive Offices) (Zip Code)

 $(714)\ 327\text{-}3000$ (Registrant's telephone number, including area code)

Check the appropriate box below if the Form 8-K filing is intended to simultaneously satisfy the filing obligation of the registrant under any of the following provisions (see General Instruction A.2. below):

- \square Written communications pursuant to Rule 425 under the Securities Act (17 CFR 230.425)
- □ Soliciting material pursuant to Rule 14a-12 under the Exchange Act (17 CFR 240.14a-12)
- □ Pre-commencement communications pursuant to Rule 14d-2(b) under the Exchange Act (17 CFR 240.14d-2(b))
- □ Pre-commencement communications pursuant to Rule 13e-4(c) under the Exchange Act (17 CFR 240.13e-4(c))

Item 7.01. Regulation FD Disclosure.

We are filing this Current Report on Form 8-K in connection with the disclosure of textual information from a slide show presentation given at the Canaccord Genuity Growth Conference and at the Jefferies Global Industrials Conference on August 14, 2013 and August 15, 2013, respectively. A copy of this slide show presentation is being furnished as Exhibit 99.1 to this Current Report on Form 8-K.

The information in this Current Report (including the exhibit) is furnished pursuant to Item 7.01 and shall not be deemed to be "filed" for the purpose of Section 18 of the Securities Exchange Act of 1934, as amended, or otherwise subject to the liabilities of that section. This Current Report will not be deemed an admission as to the materiality of any information in this Current Report that is required to be disclosed solely by Regulation FD.

We do not have, and expressly disclaim, any obligation to release publicly any updates or any changes in our expectations or any change in events, conditions, or circumstances on which any forward-looking statement is based.

The information included with this Current Report (including the exhibit) will be available at our website located atwww.ttmtech.com, although we reserve the right to discontinue that availability at any time.

The information in this report includes certain non-GAAP financial measures. The Company presents non-GAAP financial measures to enable investors to see the Company through the eyes of management and to provide better insight into the Company's ongoing financial performance. Management believes that the non-GAAP measures — which add back amortization of intangibles, stock-based compensation expense, non-cash interest expense on debt, asset impairments, restructuring and other infrequent items as well as the associated tax impact of these charges and out of period tax items — provide additional useful information to investors regarding the Company's ongoing financial conditions and results of operations. A material limitation associated with the use of the non-GAAP financial measures is that they have no standardized measurement prescribed by GAAP and may not be comparable to similar non-GAAP financial measures used by other companies. The Company compensates for these limitations by providing full disclosure of each non-GAAP financial measure and reconciliation to the most directly comparable GAAP financial measure. However, the non-GAAP financial measures should not be considered in isolation from, or as a substitute for, financial information prepared in accordance with GAAP.

The information in this Report also includes references to "Adjusted EBITDA". Adjusted EBITDA is defined as earnings before interest expense, income taxes, depreciation, amortization of intangibles, stock-based compensation expense, asset impairments and other infrequent items. We present adjusted EBITDA to enhance the understanding of our operating results. Adjusted EBITDA is a key measure we use to evaluate our operations. In addition, we provide our adjusted EBITDA because we believe that investors and securities analysts will find adjusted EBITDA to be a useful measure for evaluating our operating performance and comparing our operating performance with that of similar companies that have different capital structures and for evaluating our ability to meet our future debt service, capital expenditures and working capital requirements. However, adjusted EBITDA should not be considered as an alternative to cash flows from operating activities as a measure of liquidity or as an alternative to net income as a measure of operating results in accordance with GAAP.

Item 9.01. Financial Statements and Exhibits.

(d) Exhibits.

Exhibit No. Description

99.1 Slides presented at the Canaccord Genuity Growth Conference and at the Jefferies Global Industrials Conference on August 14, 2013, and August 15, 2013, respectively.

SIGNATURE

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned hereunto duly authorized.

TTM TECHNOLOGIES, INC.

Date: August 14, 2013

By: /s/ Todd B. Schull

Todd B. Schull

Executive Vice President, Chief Financial Officer, Treasurer and Secretary

EXHIBIT INDEX

Exhibit No. Description

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Safe Harbor

This presentation contains forward-looking statements that relate to future events or performance. These statements reflect the Company's current expectations, and the Company does not undertake to update or revise these forward-looking statements, even if experience or future changes make it clear that any projected results expressed or implied in this or other company statements will not be realized. Furthermore, readers are cautioned that these statements involve risks and uncertainties, many of which are beyond the company's control, which could cause actual results to differ materially from the forward-looking statements. These risks and uncertainties include, but are not limited to, the company's dependence upon the electronics industry, contemplated significant capital expenditures and related financing requirements, the Company's dependence upon a small number of customers, the unpredictability of and potential fluctuation in future revenues and operating results and other "Risk Factors" set forth in the Company's most recent SEC filings.

The company also will present non-GAAP financial information in this presentation. For a reconciliation of TTM's non-GAAP financial information to the equivalent measures under GAAP, please refer to the company's press release, which was filed with the SEC and which is posted on TTM's website.



TTM Differentiated Leadership Position

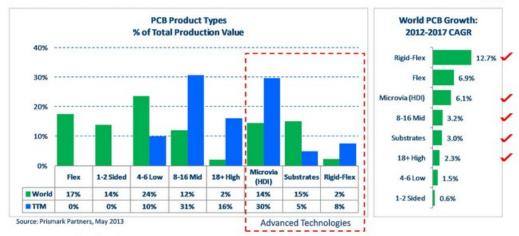
- A leading global PCB manufacturer \$1.3 billion in revenue*
- · Broad product offering with a focus on advanced technology
- Leader in Aerospace and Defense, networking and telecom, and advanced mobile devices
- Diversified end markets with broad customer base
- Strong operating cash flow generation

* Based on 2012 sales TTM Technologies

14 Specialized Manufacturing Facilities



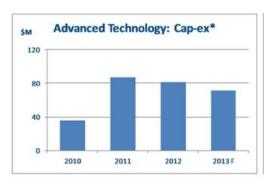
TTM is Focused on Growth in Advanced Technology

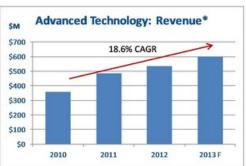


- PCB Technologies
 - Advanced HDI
 - Rigid-Flex
 - Specialty Substrates
- Product Examples
 - Smartphones
 - Touchpad Tablet PCs
 - RF and Connectivity Modules,
 Memory, Sensor, Audio, Baseband &
 Application Processors

TTM Technologies

Advanced Technology Equipment Capex





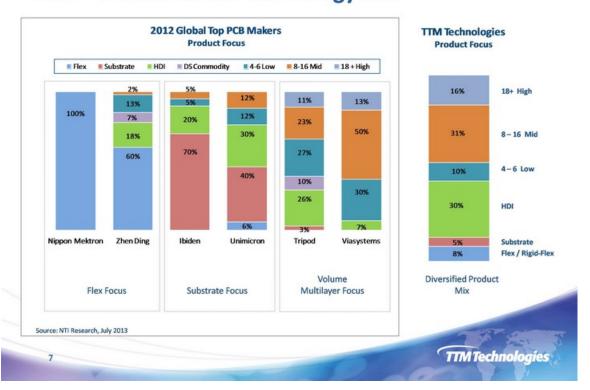
TTM is investing in the high growth segments of the market

- Over \$276 million in capex 2010-2013
- TTM is targeting growth of 18.6% CAGR in advanced technology segments 2010-2013

* 2013 estimates

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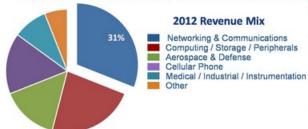
TTM - Differentiated Technology Mix



TTM End Markets



Well Positioned in Networking



2012 Net Sales \$1.3B

Available Market & CAGR

2012 PCB TAM:

\$4.6 billion

2012 Served Available Market: \$2.6 billion
 2012 – 2017 CAGR 2.8%

Source: Prismark Partners and Company estimates

Profile

- · Broadly engaged across end market
- Core supplier to a wide range of high-end networking products
- Deep penetration of wireless and wireline infrastructure segments
- · Gaining share with tier one suppliers

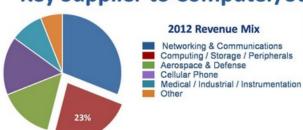
Key End Market Takeaways

- Momentum in 2H13 from 4G LTE network build out in China
- Increasing IP traffic fueling infrastructure spend by service providers
- Moderate product life cycles based on technological advancements and bandwidth demand

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TTM Technologies

Key Supplier to Computer/Storage/Peripherals



2012 Net Sales \$1.3B

Available Market & CAGR

2012 PCB TAM:

\$17.0 billion

2012 Served Available Market: \$3.8 billion
 2012 – 2017 CAGR 3.2%
 2012 – 2017 CAGR (tablets) 25%

Source: Prismark Partners and Company estimates

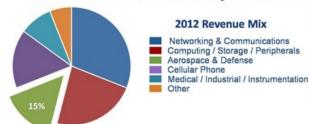
Profile

- Significant penetration in tablet segment
- Utilizes advanced HDI technology
- Core supplier to high-end servers & mainframes

Key End Market Takeaways

- Explosive growth in mobile devices and tablets driving PCB complexity
- Increasing demand for cloud services driving server and storage infrastructure products
- Moderate product life cycles

Broad Based Participation in Aerospace and Defense



Available Market & CAGR

2012 PCB TAM:

\$2.2 billion

2012 Served Available Market: \$1.0 billion 2012 – 2017 CAGR 2.2%

Source: Prismark Partners and Company estimates

2012 Net Sales \$1.3B

Profile

- Focus on high technology programs in aerospace and defense
- Leading market share in North America
- · Aligned with critical defense programs

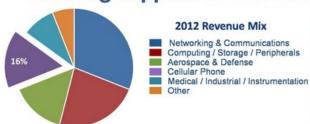
Key End Market Takeaways

- Age and fuel economy driving fleet replacement
- Defense modernization continues to drive key programs
- Very long product life cycles

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TTM Technologies

Growing Supplier to Cell Phones



2012 Net Sales \$1.3B

Available Market & CAGR

- 2012 PCB TAM:
- \$8.5 billion
- 2012 Served Available Market: \$5.4 billion
 2012 2017 CAGR 8.5%
 2012 2017 CAGR (Smartphone)
 20%

Source: Prismark Partners and Company estimates

Profile

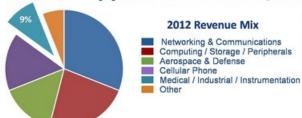
Key End Market Takeaways

to smartphones

- Focus on rapidly growing smart phone segment
- Growing business with leading smart phone manufacturers
- Utilizes advanced HDI technology

- Growth in emerging economies
- Continuing Shift from feature phones
- Short/seasonal product life cycles

HMLV Supplier to Medical/Industrial/Instrumentation



Participate equally across all three sub-

Medical - MRI and ultrasound imaging, fluid

Instrument - semiconductor test equipment,

analysis, laser surgery, patient monitoring

Industrial - power grid controls, robotics,

2012 Net Sales \$1.3B

segments

sensors

Available Market & CAGR

2012 PCB TAM:

\$3.5 billion

2012 Served Available Market: \$1.1 billion 2012 - 2017 CAGR

Source: Prismark Partners and Company estimates

Key End Market Takeaways

- Product innovation in medical diagnosis, imaging and drug delivery expanding opportunities
- Growth in wireless chip sets and memory drives demand for manufacturing & test equipment
- Conservation initiatives driving shift to more efficient power management
- Long product life cycles

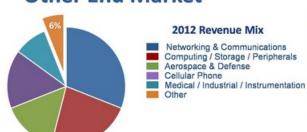
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Profile

TTM Technologies

Other End Market

network analyzers, GPS



2012 Net Sales \$1.3B

Available Market & CAGR

2012 PCB TAM:

\$9.8 billion

5.7%

2012 Served Available Market: \$1.2 billion 2012 - 2017 CAGR

Source: Prismark Partners and Company estimates

Profile

- Growing supplier to e-reader market
- Niche supplier to automotive systems makers
- Select consumer products (MP-3 players, cameras)

Key End Market Takeaways

- Seasonal demand for consumer products
- Automotive electronics driving growth
- Product life cycle varies

Strategic Initiatives

- Continued focus on delivering advanced technology to broad base of customers across diverse end markets
- Increase product mix toward advanced HDI and rigidflex
- Leverage niche position in substrates
- Evaluate M&A opportunities to drive further growth
- · Manage balance sheet for growth and risk

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TTM Technologies

Financial Overview



Non-GAAP Income Statement

\$ Millions (except where noted)	Q1 2013	Q2 2013	Q3 2013 Est.	Target Model
Asia Pacific	\$201.8	\$208.3		
North America	123.6	129.7		7% - 10%
Total Revenue	325.4	338.0	\$335 - \$355	Annual Growth
Gross Profit	51.0 15.7%	48.7 14.4%		19%
Operating Income	17.3 5.3%	15.3 4.5%		10%
TTM Net Income	9.8 3.0%	7.7 2.3%		
Earnings Per Share \$ per dluted share	0.12	0.09	\$0.13 - \$0.19	
Adjusted EBITDA	41.5 12.7%	39.1 11.6%		
Operating Cash Flow	10.4 3.2%	58.6 17.3%		

¹ Non-GAAP results add back amortization of intangibles, stock-based compensation expense, non-cash interest expense, asset impairments, restructuring and other charges as well as the associated tax impact of these charges and out of period tax items. Adjusted EBITDA is defined as earnings before interest expense, income taxes, depreciation, amortization of intangibles, stock-based compensation expense, asset impairments and other infrequent items.

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TTM Technologies

Non-GAAP Income Statement¹

\$ Millions (except where noted)	2010 ²	2011	2012
Asia Pacific	\$781.5	\$862.7	\$839.3
North America	581.8	565.9	509.4
Total Revenue	1,363.3	1,428.6	1,348.7
Gross Profit	295.8 21.7%	302.3 21.2%	226.1 16.8%
Operating Income	195.8 14.4%	179.9 12.6%	101.4 7.5%
TTM Net Income	125.5 9.2%	124.6 8.7%	69.8 5.2%
Earnings Per Share \$ per diluted share	1.56	1.52	0.85
Adjusted EBITDA	259.3	258.3	190.6
	19.0%	18.1%	14.1%
Operating Cash Flow	162.7	179.3	182.6
	11.9%	12.6%	13.5%

¹ Non-GAAP results add back amortization of intangibles, stock-based compensation expense, non-cash interest expense, asset impairments, restructuring and other charges as well as the associated tax impact of these charges and out of period tax items. Adjusted EBITDA is defined as earnings before interest expense, income taxes, depreciation, amortization of intangibles, stock-based compensation expense, asset impairments and other infrequent items.

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 $^{^2\,\}text{Pro}$ forma operating results assumed the acquisition of the Meadville PCB Subsidiaries occurred on January 1, 2010.

Balance Sheet Highlights

(\$ in millions)	December 31, 2012	July 1, 2013
Assets	-	
Cash and Cash Equivalents	\$285.4	\$230.5
Accounts and Notes Receivable, Net	301.6	221.2
Receivable from Sale of Assets	-	113.4
nventories	146.0	135.5
Property, Plant and Equipment, Net	833.7	775.8
All Other Assets	110.3	103.1
Total Assets	\$1,677.0	\$1,579.5
Liabilities and Equity		
ST Debt, Including Current Portion of LT Debt	30.0	48.1
Accounts Payable, Including Due to Related Parties	221.3	200.7
Payable for Purchase of Noncontrolling interest	-	29.1
Convertible Senior Notes, Net	157.5	160.9
Long-Term Debt, Less Current Portion	370.0	321.9
All Other Liabilities	145.4	152.9
Total Liabilities	924.2	913.6
Total Equity	752.8	665.9
Total Liabilities and Equity	\$1,677.0	\$1,579.5
		A Sev

Investment Highlights

- · Well positioned in high growth segments of the PCB market
- Market leader in advanced technology PCBs globally
- Diversified end markets with broad customer base
- Healthy balance sheet and solid cash flow funding growth



Reconciliations

\$ Millions (except where noted)	2010°	2011	2012
TTM Revenue	\$1,179.7	\$1,428.6	\$1,348.7
Meadville Revenue	183.6		
Revenue	1363.3	1428.6	1348.7
GAAP TTM Gross Profit	254.4	301.3	225.0
Meadville Gross Profit	32.7		
Gross Profit	287.1	301.3	225.0
Add back items:		2000	
Stock-based compensation	1.3	1.0	1.1
Other infrequent items	7.4	4.	
Non-GAAP Gross Profit	295.8	302.3	226.1
GAAP TTM Operating Income	125.6	91.1	(142.0)
Meadville Operating Income	14.4	-	
Operating Income	140.0	91.1	(142.0)
Add back items:			
Amortization of intangibles	17.6	17.4	14.7
Stock-based compensation	7.2	8.1	10.3
Impairment and restructuring	1.9	63.3	218,4
Transaction costs and other infrequent items	29.1	470.0	104.4
Non-GAAP Operating Income	195.8	179.9	101.4
GAAP TTM Net Income	71.5	41.9	(174.6)
Meadville Net Income	6.7		
Net Income	78.2	41.9	(174.6)
Add back items;			1000
Amortization of intangibles	17.6	17.4	14.7
Stock-based compensation Non-cash interest expense	7.2 8.1	8.1 8.2	10.3
Impairment and restructuring	1.9	63.3	218.4
Transaction costs and other infrequent items	29.1	65.5	5.5
Income tax effects	(16.6)	(14.3)	(12.4)
Non-GAAP TTM Net Income	125.5	124.6	69.8
Non-GAAP EPS (\$ per diluted share)	1.56	1.52	0.85
TTM EBITDA	193.4	186.9	(43.6)
Meadville EBITDA	27.7	100.0	(40.0)
EBITDA	221.1	186.9	(43.6)
Add back items:	277.0		1.3.01
Impairment and restructuring	1.9	63.3	218.4
Stock-based compensation and other infrequent items	36.3	8.1	15.8
Adjusted EBITDA	259.3	258.3	190.6

^{*} Pro forma operating results assumed the acquisition of the Meadville PCB Subsidiaries occurred on January 1, 2010.

Reconciliations

S Millions (except where noted)	Q1 2013	Q2 2013	
GAAP Gross Profit	\$50.7	\$48.5	
Add back item: stock-based compensation	0.3	0.2	
Non-GAAP Gross Profit	51.0	48.7	
GAAP Operating Income Add back items;	12.7	28.3	
Amortization of intangibles	2.3	2.3	
Stock-based compensation	2.3	2.6	
Gain on sale of assets	-	(17.9)	
Non-GAAP Operating Income	17.3	15.3	
GAAP TTM Net Income Add back items:	5.2	13.1	
Amortization of intangibles	2.3	2.3	
Stock-based compensation	2.3	2.6	
Non-cash interest expense	2.1	2.1	
Gain on sale of assets	-	(17.9)	
Income taxes	(2.1)	5.5	
Non-GAAP TTM Net Income	9.8	7.7	
Non-GAAP EPS (\$ per diluted share)	0.12	0.09	
GAAP Net Income Add back items:	6.6	13.7	
Income tax provision	0.8	9.4	
Interest expense	6.3	5.9	
Amortization of intangibles	2.3	2.3	
Depreciation expense	23.2	23.1	
Stock-based compensation	2.3	2.6	
Gain on sale of assets	-	(17.9)	
Adjusted EBITDA	41.5	39.1	

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TTM Technologies

IR Contacts

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